Gate Driver
BM61M41RFV-C Evaluation Board
BM61M41RFV-EVK002

User's Guide

＜High Voltage Safety Precautions＞

◇ Read all safety precautions before use

Please note that this document covers only the BM61M41RFV-C evaluation board (BM61M41RFV-EVK002) and its functions. For additional information, please refer to the datasheet.

To ensure safe operation, please carefully read all precautions before handling the evaluation board

Depending on the configuration of the board and voltages used,

Potentially lethal voltages may be generated.

Therefore, please make sure to read and observe all safety precautions described in the red box below.

Before Use

[1] Verify that the parts/components are not damaged or missing (i.e. due to the drops).
[2] Check that there are no conductive foreign objects on the board.
[3] Be careful when performing soldering on the module and/or evaluation board to ensure that solder splash does not occur.
[4] Check that there is no condensation or water droplets on the circuit board.

During Use

[5] Be careful to not allow conductive objects to come into contact with the board.
[6] **Brief accidental contact or even bringing your hand close to the board may result in discharge and lead to severe injury or death.**

Therefore, DO NOT touch the board with your bare hands or bring them too close to the board.
In addition, as mentioned above please exercise extreme caution when using conductive tools such as tweezers and screwdrivers.

[7] If used under conditions beyond its rated voltage, it may cause defects such as short-circuit or, depending on the circumstances, explosion or other permanent damages.
[8] Be sure to wear insulated gloves when handling is required during operation.

After Use

[9] The ROHM Evaluation Board contains the circuits which store the high voltage. Since it stores the charges even after the connected power circuits are cut, please discharge the electricity after using it, and please deal with it after confirming such electric discharge.
[10] Protect against electric shocks by wearing insulated gloves when handling.

This evaluation board is intended for use only in research and development facilities and should by handled **only by qualified personnel familiar with all safety and operating procedures.**
We recommend carrying out operation in a safe environment that includes the use of high voltage signage at all entrances, safety interlocks, and protective glasses.

Isolated Gate Driver

BM61M41RFV-C Evaluation Board

BM61M41RFV-EVK002

The BM61M41RFV-EVK002 board can be driving two MOSFET Power Devices such as for High-side and Low-side on Half-Bridge application. The Input-side power supply voltage is from 4.5 to 5.5 V. The output-side power supply is from 9 to 24 V. The BM61M41RFV-C has Power Supply protections which are the Under-Voltage Lockout (UVLO) function at Input-side and Output-side. The Active Miller Clamping is included for gate control. The BM61M41RFV-EVK002 allows designers to evaluate Rohm's Gate Driver family for various applications.

Application

MOSFET Gate Drive

Electric Characteristics

Features and electric characteristics are complied with BM61M41RFV-C. The BM61M41RFV-C datasheet can be referenced to help facilitate designs.

Operating Range

Parameter	Symbol	Min	Max	Units
Input-side Supply Voltage	VCC1*(Note 1)*	4.5	5.5	V
Output-side Supply Voltage	VCC2*(Note 2)*	9	24	V
Operating Temperature	Topr	-40	+125	°C

(Note 1): Relative to GND1
(Note 2): Relative to GND2

Absolute Maximum Ratings

Parameter	Symbol	Limits	Units
Input-side Supply Voltage	VCC1	-0.3 to +7.0*(Note 3)*	V
Output-side Supply Voltage	VCC2	-0.3 to +30.0*(Note 4)*	V
INA Pin Input Voltage	V_{INA}	-0.3 to +VCC1+0.3 or +7.0*(Note 3)*	V
INB Pin Input Voltage	V_{INB}	-0.3 to +VCC1+0.3 or +7.0*(Note 3)*	V

(Note 3): Relative to GND1
(Note 4): Relative to GND2

No. 62UG038E Rev.001
2019.10

Terminal Descriptions

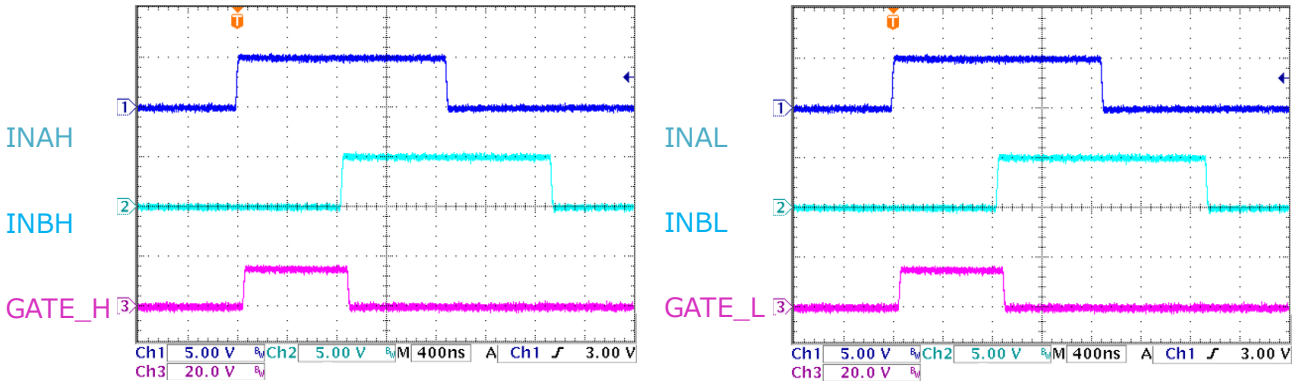
Pin name	Description
VCC1	Input-side Power Supply
INAH	Input-side Control A on High-side
INBH	Input-side Control B on High-side
INAL	Input-side Control A on Low-side
INBL	Input-side Control B on Low-side
GND1	Input-side Ground
GND2L	Output-side Ground on Low-side
GATE_L	Output-side Gate Control on Low-side
VCC2L	Output-side Power Supply on Low-side
GND2H	Output-side Ground on High-side
GATE_H	Output-side Gate Control on High side
VCC2H	Output-side Power Supply on High side

Input / Output terminal Control

INAH (input)	INBH (input)	GATE_H (Output)
L	H	L
H	H	L
L	L	L
H	L	H

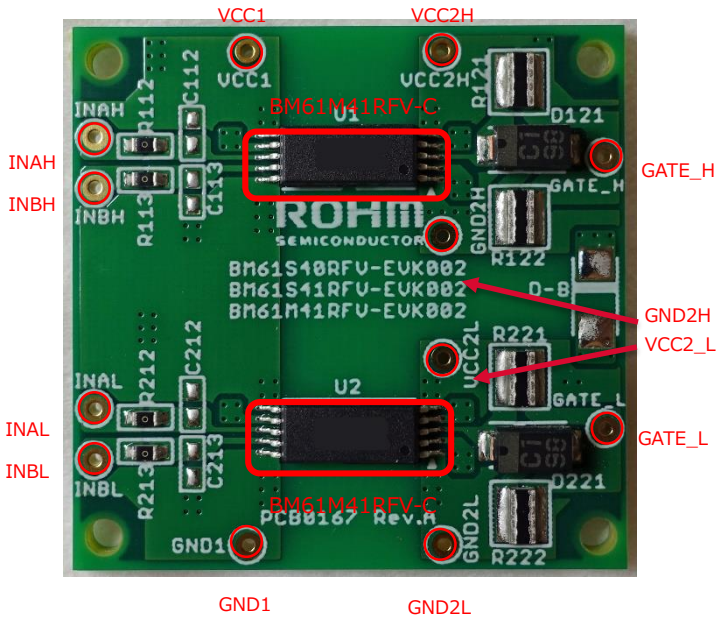
INAL (input)	INBL (input)	GATE_L (Output)
L	H	L
H	H	L
L	L	L
H	L	H

Waveform

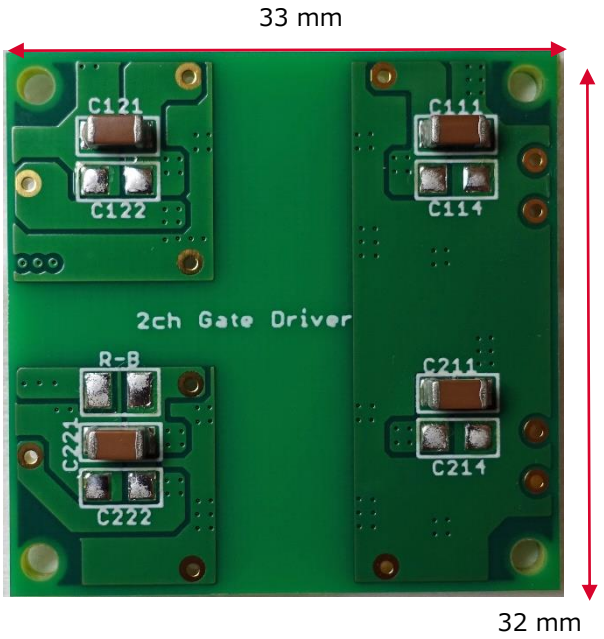


Evaluation Board

Front

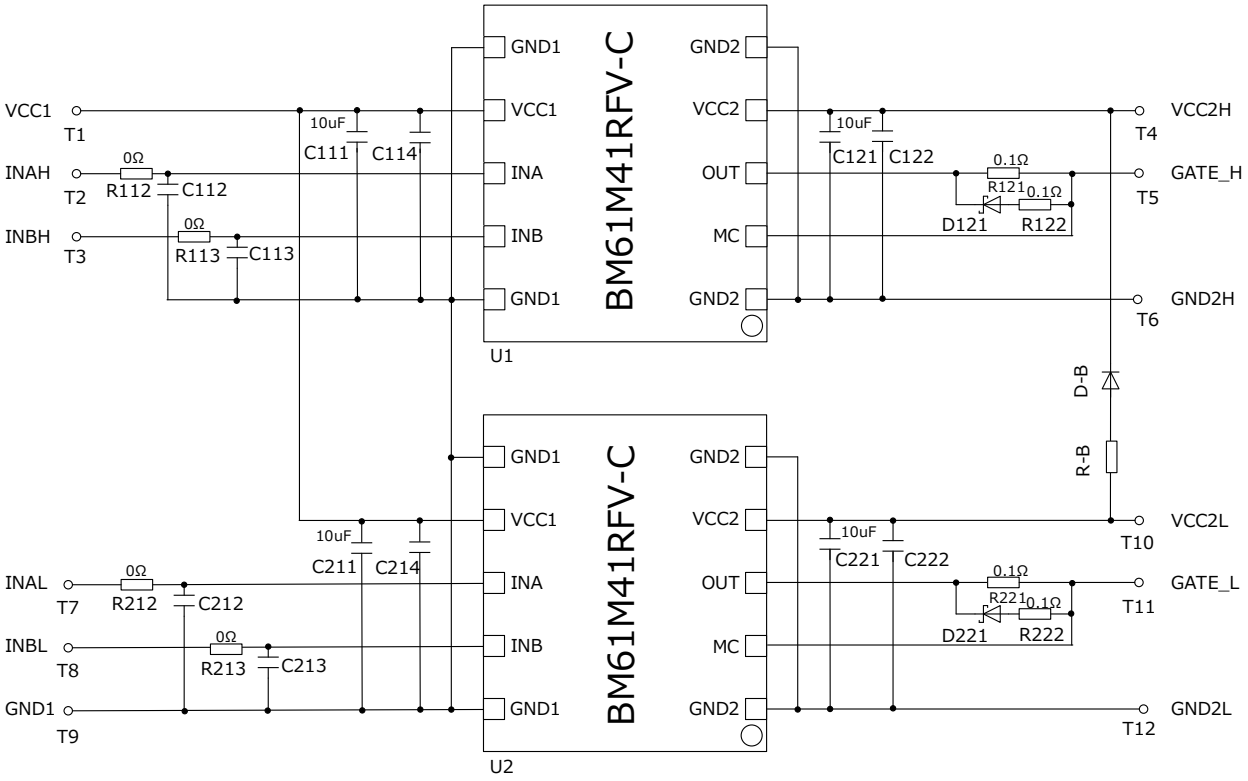


Back



Schematics

R112, R113, R121, R122, R212, R213, R221, and R222 are implemented interim resisters for shipment check. Please replace each resister which can work with Power Device or input device appropriately.



Bill of Materials

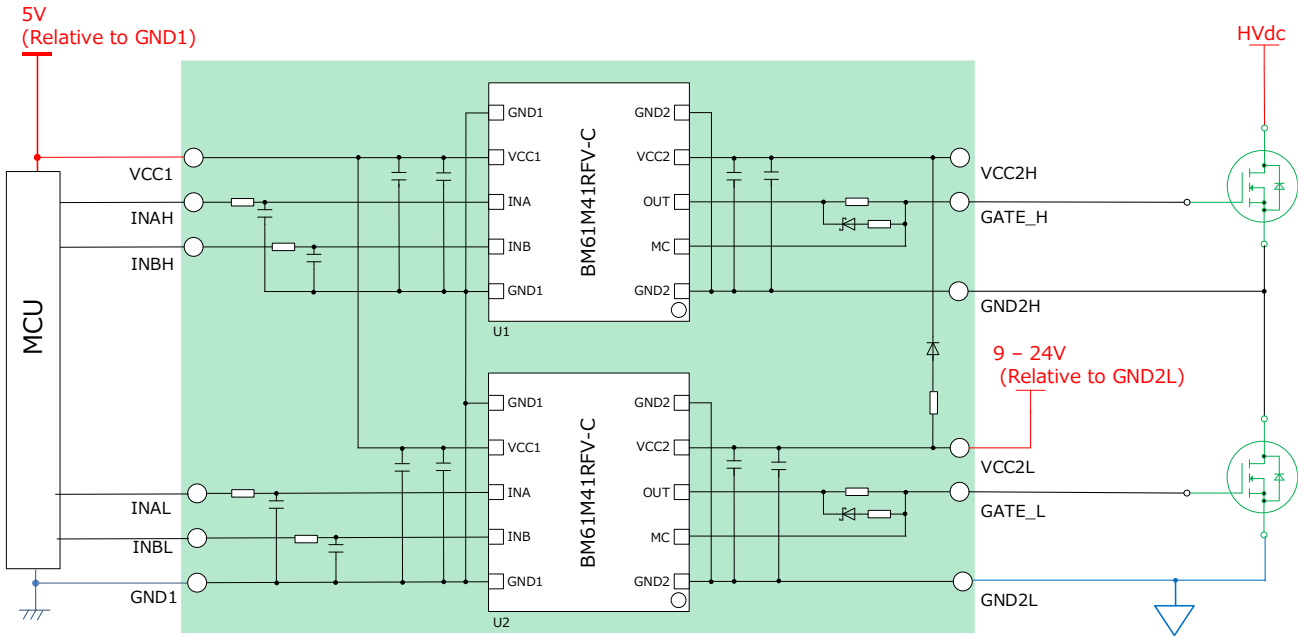
Device	Parts No.	Description	Manufacturer	Parts name	Qty.
Gate Driver	U1, U2	1ch, 9-24V	ROHM	BM61M41RFV-C	2
Input Capacitor	C111, C211	10uF, 50V, X7R, 3216	TDK	CGA5L1X7R1H106K160	2
	C114, C214	(no stuff)			0
Input signal filter	R112, R113, R212, R213	0 ohm, 1608	ROHM	MCR03EZPJ000	4
	C112, C113, C212, C213	(no stuff)			0
Output Capacitor	C121, C221	10uF, 50V, X7R, 3216	TDK	CGA5L1X7R1H106K160	2
	C122, C222	(no stuff)			0
Gate	R121, R221	0.1 ohm, 3216	ROHM	LTR18EZPJLR10	2
	R122,R222	0.1 ohm, 3216	ROHM	LTR18EZPJLR10	2
	D121, D122	Schottky Diode, 30V, 5A	ROHM	RBR5L30BDD	2
Bootstrap	D-B	(no stuff)			0
	R-B	(no stuff)			0
Test pin	T1, T2, T3, T4, T5, T6, T7, T8, T9, T10, T11, T12 (Option)	(no stuff)	Hirosugi-Keiki	HT-0710-3	12
Spacer	(Option)	M2, 10mm	Hirosugi-Keiki	BSN2010	4
Nut	(Option)	M2	Hirosugi-Keiki	NNT-00	4

Materials may be changed without notice.

Application and Operation procedure

Following figure is shown the example application. MOSFET and microcontroller [MCU] are connected to the board via terminals. VCC2H power can be supplied from VCC2L by using bootstrap circuit. Please place appropriate components on the EVK for bootstrap. Please make sure to replace the appropriate value for each resistor and capacitor on the board depends on your applications. The numerous application notes can be referenced to help facilitate designs. Useful application notes are listed on page 8.

Example Application



Additional Components for Bootstrapping

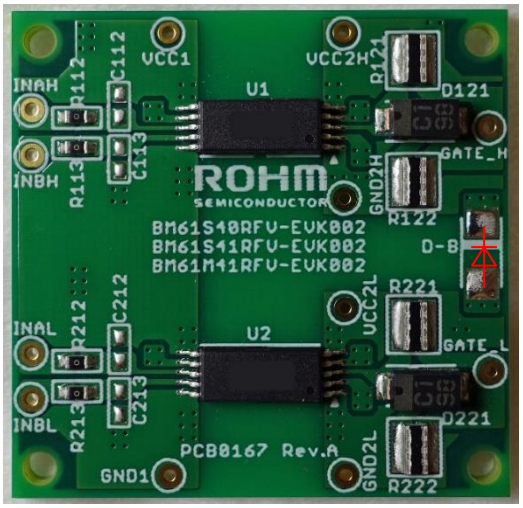
R-B and D-B parts are for bootstrapping. Place appropriate components depends on your applications.

Examples:

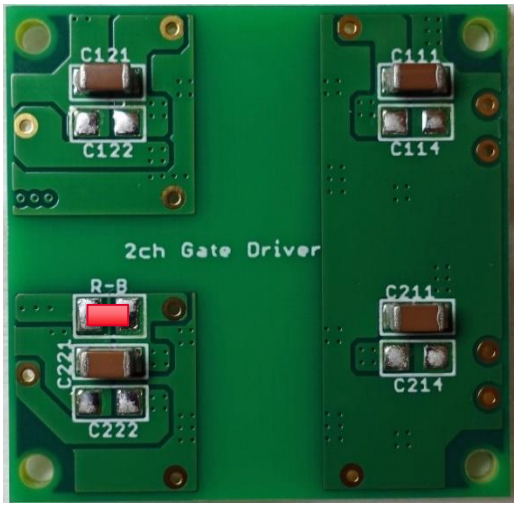
D-B: ROHM RFN2LAM6STF [Reverse voltage: 600V, Current: 1.5A, Package: PMDTM]

R-B: ROHM ESR18 series resistor [Package size: 3216mm]

Front



Back



Equipment

- DC Power Supply: 5 V for control signal [5 VDC], 9 to 24 V for Power Device [9 to 24 VDC]
- Microcontroller [MCU]: Input signal for controlling GATE output
- Power Device: MOSFET
  We have many power devices which can work with Evaluation Board. You can get applicable product information from our web site. Some products are shown on page 8.

Instructions

Before start to connect, make sure to turn off all equipment for your safety.

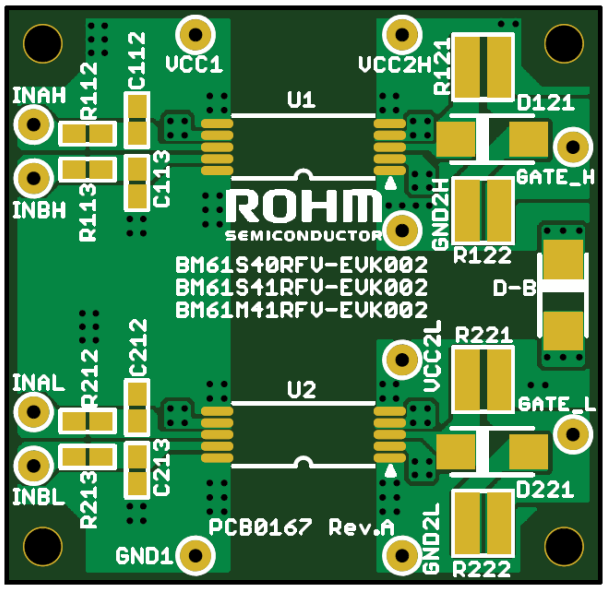
1. Connect 5 VDC to VCC1–GND1 terminal on board.
   Stay turn off the power supply.
2. Connect 9 to 24 VDC to VCC2L-GND2L terminal on board.
   Stay turn off the power supply.
3. Connect MCU to the INAH, INBH, INAL, and INBL terminal on board.
   Refer to the Input / Output terminal Control description on page 2.
4. Connect GATE_H and GATE_L terminal on board to each gate terminal on power devices.
5. Turn on the 5 VDC and MCU.
6. Turn on the 9 to 24 VDC.

PCB Layout

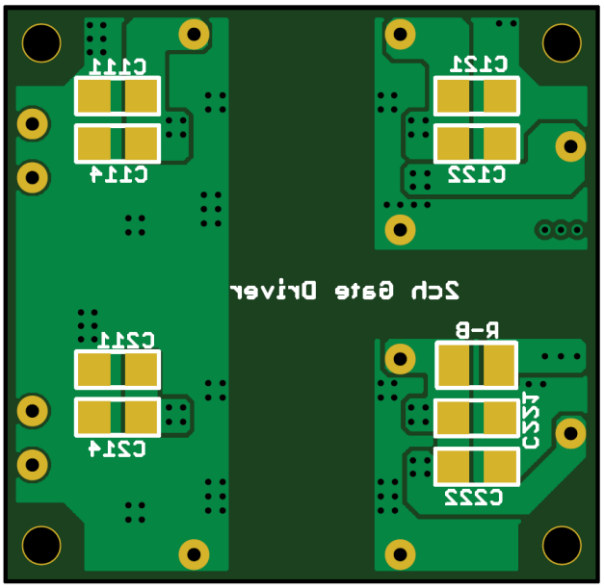
Board size: 33 x 32 mm, Material:FR-4, 4-layer.

Input-side capacitors and output capacitors [C111, C114, C121, C122, C211, C214, C221, and C222] are placed on bottom side in order to reduce board size. When you design your PCB layout, we recommend to place them to the same side and near the gate driver as close as possible.

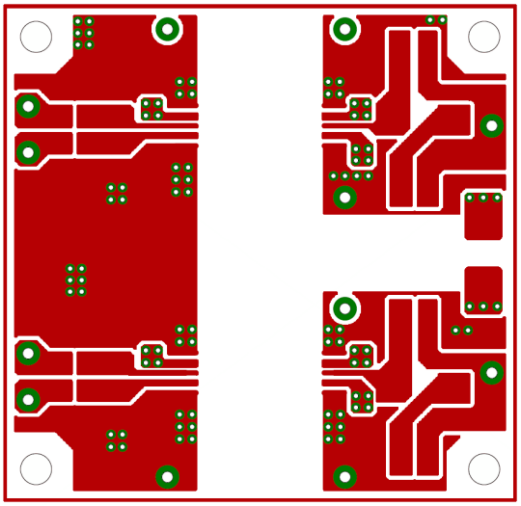
Top Layer with Pad and Silkscreen (Top View)



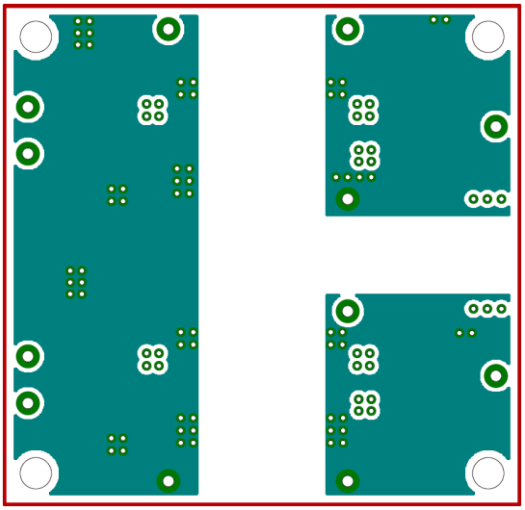
Bottom Layer with Pad and Silkscreen (Top View)



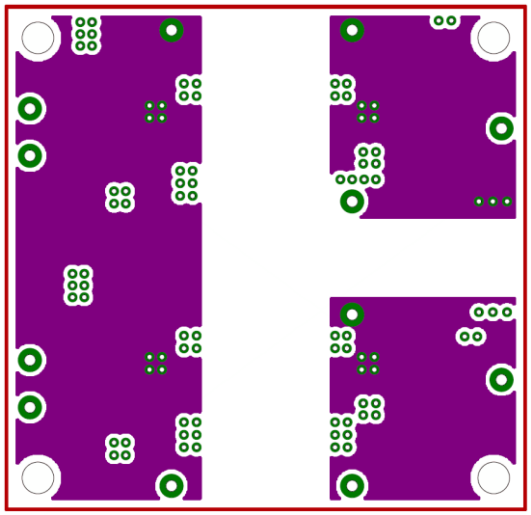
Top Layer (Top View)



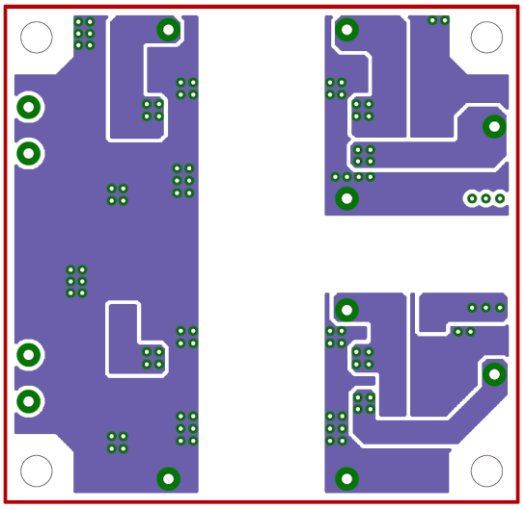
2nd Layer (Top View)



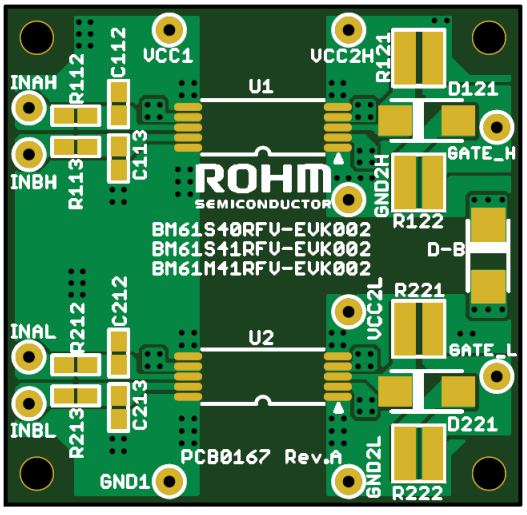
3rd Layer (Top View)



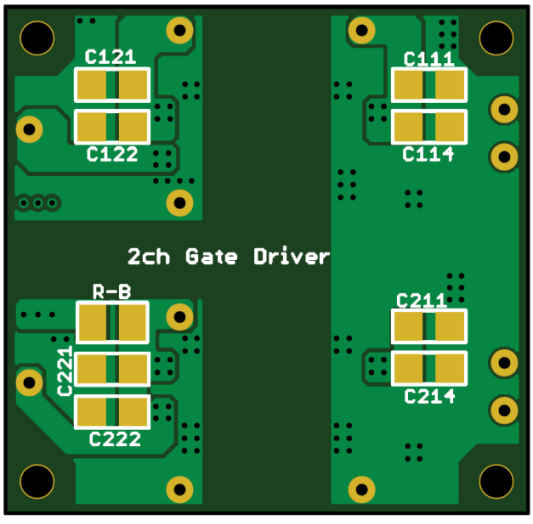
Bottom Layer (Top View)



Silkscreen (Top)



Silkscreen (Bottom)



We have numerous power devices which are suitable for your requests.
For the MOSFET, please visit our web site below:
https://www.rohm.com/products/transistors/mosfets

Following examples are MOSFET for high-speed switching specifications.

Matching Products	Drain-Source Voltage VDSS[V]	Polarity	Drain Current [A]	RDS(on)[Ohm] VGS=Drive (Typ.)	Drive Voltage [V]	Package code
R6504KNJ	650	Nch	4	0.955	10	TO-263 (D2PAK)
R6507KNJ			7	0.605		
R6509KNJ			9	0.53		
R6511KNJ			11	0.36		
R6515KNJ			15	0.28		
R6520KNJ			20	0.185		
R6524KNJ			24	0.16		
R6504KNX			4	0.955		TO-220FM
R6509KNX			9	0.53		
R6511KNX			11	0.36		
R6515KNX			15	0.28		
R6520KNX			20	0.185		
R6524KNX			24	0.16		
R6530KNX			30	0.125		
R6520KNZ4			20	0.185		TO-247
R6547KNZ4			47	0.07		

We also offer useful power device application notes for design and evaluation.
Please visit our web site below:
https://www.rohm.com/search/application-notes

1. Gate-source voltage behavior in a bridge configuration, No.60AN135E
2. Gate-Source Voltage Surge Suppression Methods, No.62AN010E
3. Snubber circuits design method for SiC MOSFET, No.62AN037E
4. Switching Loss improvement by TO-247-4L with Driver Source, No.62AN04E

Revision History

Date	Revision Number	Description
2019.10	001	New Release

Notes

1) The information contained herein is subject to change without notice.

2) Before you use our Products, please contact our sales representative and verify the latest specifications :

3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.
Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.

4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.

6) The Products specified in this document are not designed to be radiation tolerant.

7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.

8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.

9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.

10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.

11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.

12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.

13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.

ROHM SEMICONDUCTOR

Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Power Management IC Development Tools ***category:***

Click to view products by ROHM ***manufacturer:***

Other Similar products are found below :

EVAL-ADM1168LQEBZ EVB-EP5348UI MIC23451-AAAYFL EV MIC5281YMME EV DA9063-EVAL ADP122-3.3-EVALZ ADP130-0.8-EVALZ ADP130-1.2-EVALZ ADP130-1.5-EVALZ ADP130-1.8-EVALZ ADP1714-3.3-EVALZ ADP1716-2.5-EVALZ ADP1740-1.5-EVALZ ADP1752-1.5-EVALZ ADP1828LC-EVALZ ADP1870-0.3-EVALZ ADP1871-0.6-EVALZ ADP1873-0.6-EVALZ ADP1874-0.3-EVALZ ADP1882-1.0-EVALZ ADP199CB-EVALZ ADP2102-1.25-EVALZ ADP2102-1.875EVALZ ADP2102-1.8-EVALZ ADP2102-2-EVALZ ADP2102-3-EVALZ ADP2102-4-EVALZ ADP2106-1.8-EVALZ ADP2147CB-110EVALZ AS3606-DB BQ24010EVM BQ24075TEVM BQ24155EVM BQ24157EVM-697 BQ24160EVM-742 BQ24296MEVM-655 BQ25010EVM BQ3055EVM NCV891330PD50GEVB ISLUSBI2CKIT1Z LM2744EVAL LM2854EVAL LM3658SD-AEV/NOPB LM3658SDEV/NOPB LM3691TL-1.8EV/NOPB LM4510SDEV/NOPB LM5033SD-EVAL LP38512TS-1.8EV EVAL-ADM1186-1MBZ EVAL-ADM1186-2MBZ